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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	8051
Core Size	8-Bit
Speed	25MHz
Connectivity	SMBus (2-Wire/I²C), UART/USART
Peripherals	POR, PWM, WDT
Number of I/O	8
Program Memory Size	8KB (8K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	10-VFDFN Exposed Pad
Supplier Device Package	11-QFN (3x3)
Purchase URL	https://www.e-xfl.com/product-detail/silicon-labs/c8051f301r

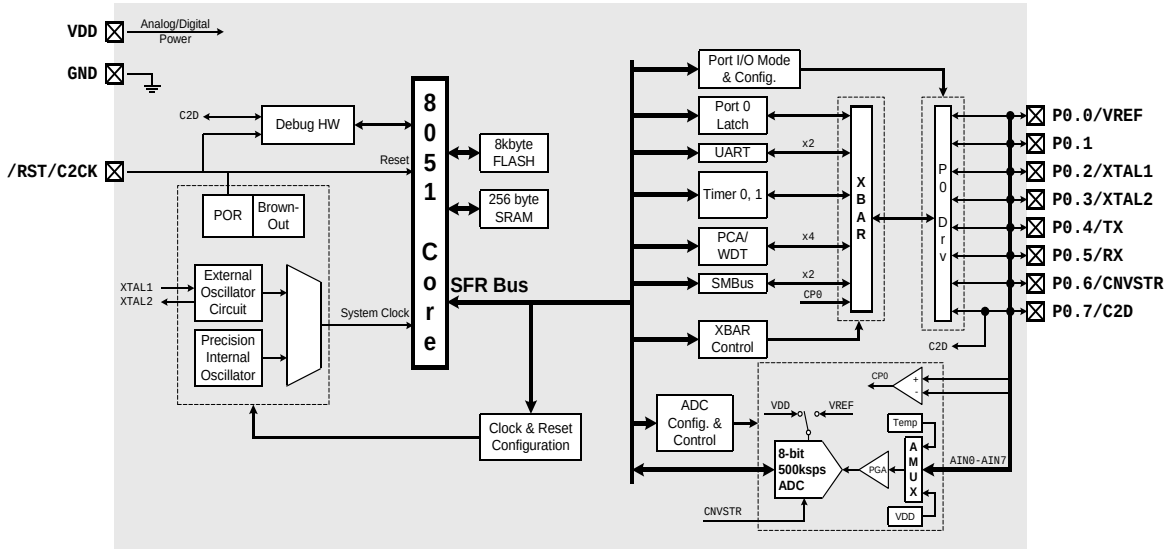

Figure 1.1. C8051F300/2 Block Diagram

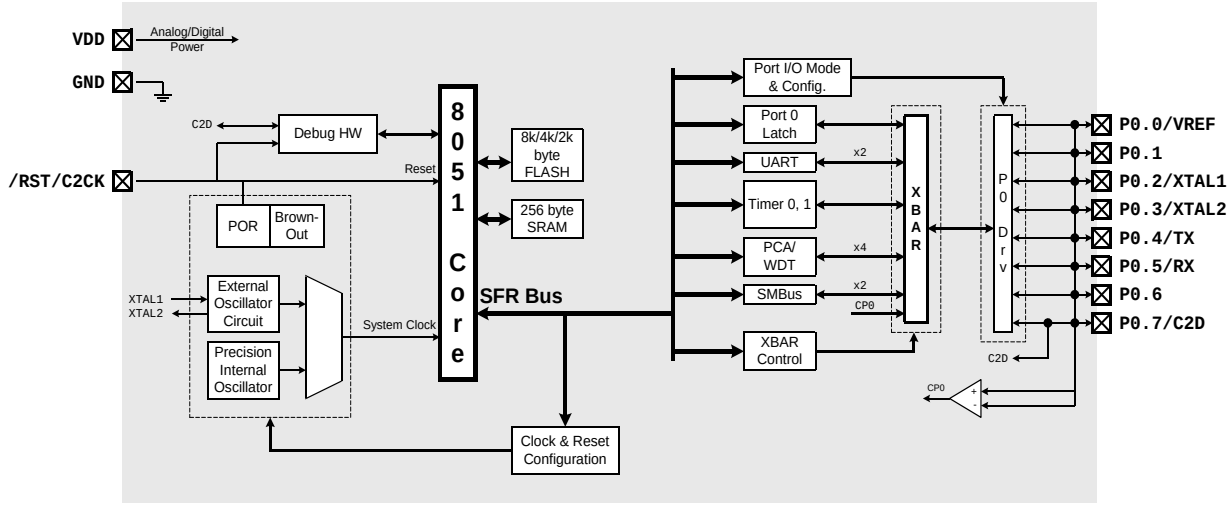

Figure 1.2. C8051F301/3/4/5 Block Diagram

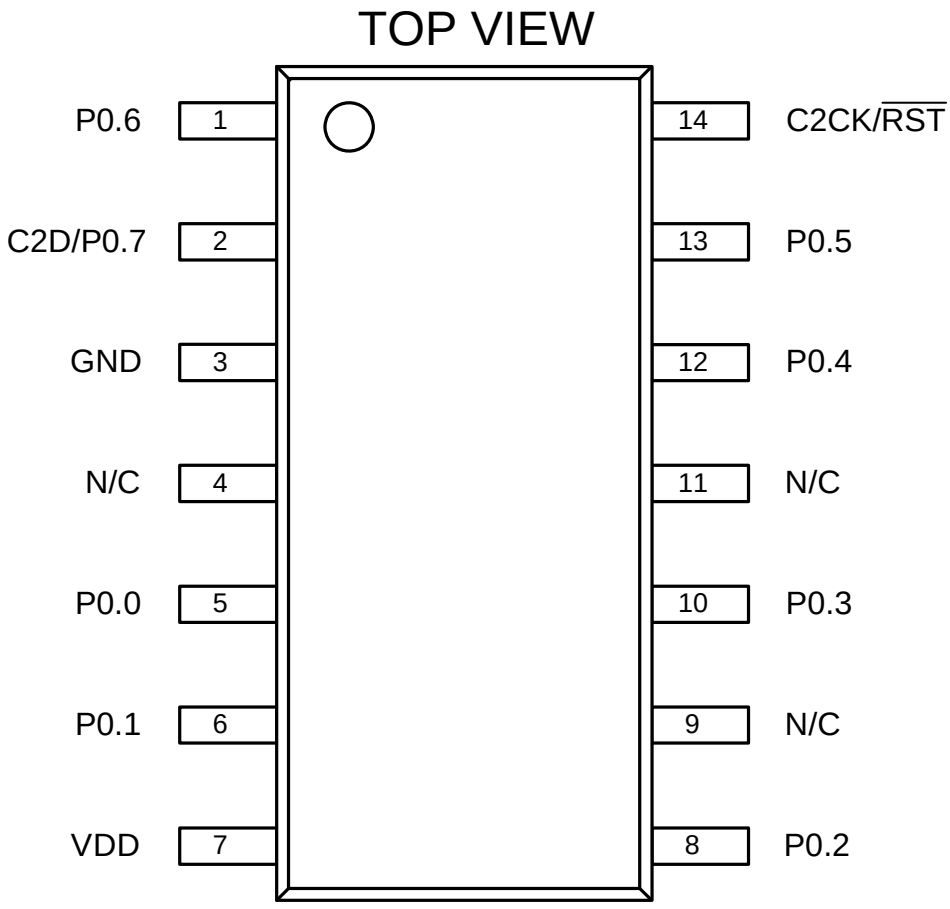

Figure 4.5. SOIC-14 Pinout Diagram (Top View)

Table 5.1. ADC0 Electrical Characteristics

V_{DD} = 3.0 V, VREF = 2.40 V (REFSL = 0), PGA Gain = 1, –40 to +85 °C unless otherwise specified.

Parameter	Conditions	Min	Typ	Max	Units
DC Accuracy					
Resolution			8		bits
Integral Nonlinearity		—	±0.5	±1	LSB
Differential Nonlinearity	Guaranteed Monotonic	—	±0.5	±1	LSB
Offset Error		–5.0	0.5	5.0	LSB
Full Scale Error	Differential mode	–5.0	–1	5.0	LSB
Dynamic Performance (10 kHz Sine-wave Differential Input, 1 dB below Full Scale, 500 ksps)					
Signal-to-Noise Plus Distortion		45	48	—	dB
Total Harmonic Distortion	Up to the 5th harmonic	—	–56	—	dB
Spurious-Free Dynamic Range		—	58	—	dB
Conversion Rate					
SAR Conversion Clock		—	—	6	MHz
Conversion Time in SAR Clocks		11	—	—	clocks
Track/Hold Acquisition Time		300	—	—	ns
Throughput Rate		—	—	500	ksps
Analog Inputs					
Input Voltage Range		0	—	VREF	V
Input Capacitance		—	5	—	pF
Temperature Sensor		—	—	—	
Linearity[1,2,3]		—	±0.5	—	°C
Gain[1,2,3]		—	3350 ±110	—	µV / °C
Offset[1,2,3]	(Temp = 0 °C)	—	897±31	—	mV
Power Specifications					
Power Supply Current (V_{DD} supplied to ADC0)	Operating Mode, 500 ksps	—	400	900	µA
Power Supply Rejection		—	±0.3	—	mV/V

Notes:
1. Represents one standard deviation from the mean.
2. Measured with PGA Gain = 2.
3. Includes ADC offset, gain, and linearity variations.

SFR Definition 7.2. CPT0MX: Comparator0 MUX Selection

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
—	—	CMX0N1	CMX0N0	—	—	CMX0P1	CMX0P0	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0x9F

Bits7–6: UNUSED. Read = 00b, Write = don't care.
Bits6–4: CMX0N1–CMX0N0: Comparator0 Negative Input MUX Select.
These bits select which Port pin is used as the Comparator0 negative input.

CMX0N1	CMX0N0	Negative Input
0	0	P0.1
0	1	P0.3
1	0	P0.5
1	1	P0.7

Bits3–2: UNUSED. Read = 00b, Write = don't care.
Bits1–0: CMX0P1–CMX0P0: Comparator0 Positive Input MUX Select.
These bits select which Port pin is used as the Comparator0 positive input.

CMX0P1	CMX0P0	Positive Input
0	0	P0.0
0	1	P0.2
1	0	P0.4
1	1	P0.6

SFR Definition 7.3. CPT0MD: Comparator0 Mode Selection

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
—	—	—	—	—	—	CP0MD1	CP0MD0	00000010
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0x9D

Bits7–2: UNUSED. Read = 000000b, Write = don't care.
Bits1–0: CP0MD1–CP0MD0: Comparator0 Mode Select.
These bits select the response time for Comparator0.

Mode	CP0MD1	CP0MD0	CP0 Response Time (TYP)
0	0	0	Fastest Response Time
1	0	1	—
2	1	0	—
3	1	1	Lowest Power Consumption

NOTES:

Table 8.2. Special Function Register (SFR) Memory Map

F8	CPT0CN	PCA0L	PCA0H	PCA0CPL0	PCA0CPH0			
F0	B	P0MDIN					EIP1	
E8	ADC0CN	PCA0CPL1	PCA0CPH1	PCA0CPL2	PCA0CPH2			RSTSRC
E0	ACC	XBR0	XBR1	XBR2	IT01CF		EIE1	
D8	PCA0CN	PCA0MD	PCA0CPM0	PCA0CPM1	PCA0CPM2			
D0	PSW	REF0CN						
C8	TMR2CN		TMR2RLL	TMR2RLH	TMR2L	TMR2H		
C0	SMB0CN	SMB0CF	SMB0DAT		ADC0GT		ADC0LT	
B8	IP			AMX0SL	ADC0CF		ADC0	
B0		OSCXCN	OSCICN	OSCICL			FLSCL	FLKEY
A8	IE							
A0					P0MDOUT			
98	SCON0	SBUF0				CPT0MD		CPT0MX
90								
88	TCON	TMOD	TL0	TL1	TH0	TH1	CKCON	PSCTL
80	P0	SP	DPL	DPH				PCON
	0(8)	1(9)	2(A)	3(B)	4(C)	5(D)	6(E)	7(F)

(bit addressable)

Table 8.3. Special Function Registers*

Register	Address	Description	Page No.
ACC	0xE0	Accumulator	71
ADC0CF	0xBC	ADC0 Configuration	43
ADC0CN	0xE8	ADC0 Control	44
ADC0GT	0xC4	ADC0 Greater-Than Compare Word	46
ADC0LT	0xC6	ADC0 Less-Than Compare Word	46
ADC0	0xBE	ADC0 Data Word	43
AMX0SL	0xBB	ADC0 Multiplexer Channel Select	42
B	0xF0	B Register	71
CKCON	0x8E	Clock Control	149
CPT0CN	0xF8	Comparator0 Control	53
CPT0MD	0x9D	Comparator0 Mode Selection	54
CPT0MX	0x9F	Comparator0 MUX Selection	54
DPH	0x83	Data Pointer High	69
DPL	0x82	Data Pointer Low	68
EIE1	0xE6	Extended Interrupt Enable 1	77
EIP1	0xF6	External Interrupt Priority 1	78
FLKEY	0xB7	Flash Lock and Key	93

***Note:** SFRs are listed in alphabetical order. All undefined SFR locations are reserved

SFR Definition 8.2. DPH: Data Pointer High Byte

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address:
								0x83

Bits7–0: DPH: Data Pointer High.
The DPH register is the high byte of the 16-bit DPTR. DPTR is used to access indirectly addressed Flash memory.

SFR Definition 8.3. SP: Stack Pointer

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000111
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address:
								0x81

Bits7–0: SP: Stack Pointer.
The Stack Pointer holds the location of the top of the stack. The stack pointer is incremented before every PUSH operation. The SP register defaults to 0x07 after reset.

SFR Definition 10.2. FLKEY: Flash Lock and Key

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address:
								0xB7

Bits7–0: FLKEY: Flash Lock and Key Register
Write:
This register must be written to before Flash writes or erases can be performed. Flash remains locked until this register is written to with the following key codes: 0xA5, 0xF1. The timing of the writes does not matter, as long as the codes are written in order. The key codes must be written for each Flash write or erase operation. Flash will be locked until the next system reset if the wrong codes are written or if a Flash operation is attempted before the codes have been written correctly.
Read:
When read, bits 1–0 indicate the current Flash lock state.
00: Flash is write/erase locked.
01: The first key code has been written (0xA5).
10: Flash is unlocked (writes/erases allowed).
11: Flash writes/erases disabled until the next reset.

SFR Definition 10.3. FLSCL: Flash Scale

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
FOSE	Reserved	Reserved	Reserved	Reserved	Reserved	Reserved	Reserved	10000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address:
								0xB6

Bits7: FOSE: Flash One-shot Enable
This bit enables the 50 ns Flash read one-shot. When the Flash one-shot disabled, the Flash sense amps are enabled for a full clock cycle during Flash reads.
0: Flash one-shot disabled.
1: Flash one-shot enabled.
Bits6–0: RESERVED. Read = 0. Must Write 0.

10.4. Flash Write and Erase Guidelines

Any system which contains routines which write or erase Flash memory from software involves some risk that the write or erase routines will execute unintentionally if the CPU is operating outside its specified operating range of V_{DD}, system clock frequency, or temperature. This accidental execution of Flash modifying code can result in alteration of Flash memory contents causing a system failure that is only recoverable by re-Flashing the code in the device.

The following guidelines are recommended for any system which contains routines which write or erase Flash from code.

10.4.1. V_{DD} Maintenance and the V_{DD} monitor

1. If the system power supply is subject to voltage or current "spikes," add sufficient transient protection devices to the power supply to ensure that the supply voltages listed in the Absolute Maximum Ratings table are not exceeded.
2. Make certain that the minimum V_{DD} rise time specification of 1 ms is met. If the system cannot meet this rise time specification, then add an external V_{DD} brownout circuit to the $\overline{RST}$ pin of the device that holds the device in reset until V_{DD} reaches 2.7 V and re-asserts $\overline{RST}$ if V_{DD} drops below 2.7 V.
3. Enable the on-chip V_{DD} monitor and enable the V_{DD} monitor as a reset source as early in code as possible. This should be the first set of instructions executed after the Reset Vector. For 'C'-based systems, this will involve modifying the startup code added by the 'C' compiler. See your compiler documentation for more details. Make certain that there are no delays in software between enabling the V_{DD} monitor and enabling the V_{DD} monitor as a reset source. Code examples showing this can be found in “AN201: Writing to Flash from Firmware", available from the Silicon Laboratories web site.
4. As an added precaution, explicitly enable the V_{DD} monitor and enable the V_{DD} monitor as a reset source inside the functions that write and erase Flash memory. The V_{DD} monitor enable instructions should be placed just after the instruction to set PSWE to a '1', but before the Flash write or erase operation instruction.
5. Make certain that all writes to the RSTSRC (Reset Sources) register use direct assignment operators and explicitly DO NOT use the bit-wise operators (such as AND or OR). For example, "RSTSRC = 0x02" is correct. "RSTSRC |= 0x02" is incorrect.
6. Make certain that all writes to the RSTSRC register explicitly set the PORSF bit to a '1'. Areas to check are initialization code which enables other reset sources, such as the Missing Clock Detector or Comparator, for example, and instructions which force a Software Reset. A global search on "RSTSRC" can quickly verify this.

10.4.2. PSWE Maintenance

7. Reduce the number of places in code where the PSWE bit (b0 in PSCTL) is set to a '1'. There should be exactly one routine in code that sets PSWE to a '1' to write Flash bytes and one routine in code that sets PSWE and PSEE both to a '1' to erase Flash pages.
8. Minimize the number of variable accesses while PSWE is set to a '1'. Handle pointer address updates and loop variable maintenance outside the "PSWE = 1; ... PSWE = 0;" area. Code examples showing this can be found in *AN201, "Writing to Flash from Firmware"*, available from the Silicon Laboratories web site.
9. Disable interrupts prior to setting PSWE to a '1' and leave them disabled until after PSWE has been reset to '0'. Any interrupts posted during the Flash write or erase operation will be ser-

SFR Definition 11.1. OSCICL: Internal Oscillator Calibration

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
—								Variable
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address:
								0xB3

Bit7: UNUSED. Read = 0. Write = don't care.
Bits 6–0: OSCICL: Internal Oscillator Calibration Register.
This register calibrates the internal oscillator period. The reset value for OSCICL defines the internal oscillator base frequency. On C8051F300/1 devices, the reset value is factory calibrated to generate an internal oscillator frequency of 24.5 MHz.

SFR Definition 11.2. OSCICN: Internal Oscillator Control

R/W	R/W	R/W	R	R/W	R/W	R/W	R/W	Reset Value
—	—	—	IFRDY	CLKSL	IOSCEN	IFCN1	IFCN0	00010100
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address:
								0xB2

Bits7–5: UNUSED. Read = 000b, Write = don't care.
Bit4: IFRDY: Internal Oscillator Frequency Ready Flag.
0: Internal Oscillator is not running at programmed frequency.
1: Internal Oscillator is running at programmed frequency.
Bit3: CLKSL: System Clock Source Select Bit.
0: SYSCLK derived from the Internal Oscillator, and scaled as per the IFCN bits.
1: SYSCLK derived from the External Oscillator circuit.
Bit2: IOSCEN: Internal Oscillator Enable Bit.
0: Internal Oscillator Disabled.
1: Internal Oscillator Enabled.
Bits1–0: IFCN1-0: Internal Oscillator Frequency Control Bits.
00: SYSCLK derived from Internal Oscillator divided by 8.
01: SYSCLK derived from Internal Oscillator divided by 4.
10: SYSCLK derived from Internal Oscillator divided by 2.
11: SYSCLK derived from Internal Oscillator divided by 1.

Table 11.1. Internal Oscillator Electrical Characteristics

–40 to +85 °C unless otherwise specified

Parameter	Conditions	Min	Typ	Max	Units
Calibrated Internal Oscillator Frequency	C8051F300/1 devices –40 to +85 °C	24	24.5	25	MHz
	C8051F300/1 devices 0 to +70 °C	24.3	24.7	25	MHz
Uncalibrated Internal Oscillator Frequency	C8051F302/3/4/5 devices	16	20	24	MHz
Internal Oscillator Supply Current (from V_{DD})	OSCICN.2 = 1		450		µA

11.2. External Oscillator Drive Circuit

The external oscillator circuit may drive an external crystal, ceramic resonator, capacitor, or RC network. A CMOS clock may also provide a clock input. For a crystal or ceramic resonator configuration, the crystal/resonator must be wired across the XTAL1 and XTAL2 pins as shown in Option 1 of Figure 11.1. A 10 MΩ resistor also must be wired across the XTAL2 and XTAL1 pins for the crystal/resonator configuration. In RC, capacitor, or CMOS clock configuration, the clock source should be wired to the XTAL2 pin as shown in Option 2, 3, or 4 of Figure 11.1. The type of external oscillator must be selected in the OSCXCN register, and the frequency control bits (XFCN) must be selected appropriately (see SFR Definition 11.3).

Important Note on External Oscillator Usage: Port pins must be configured when using the external oscillator circuit. When the external oscillator drive circuit is enabled in crystal/resonator mode, Port pins P0.2 and P0.3 are occupied as XTAL1 and XTAL2 respectively. When the external oscillator drive circuit is enabled in capacitor, RC, or CMOS clock mode, Port pin P0.3 is occupied as XTAL2. The Port I/O Crossbar should be configured to skip the occupied Port pins; see **Section “12.1. Priority Crossbar Decoder” on page 104** for Crossbar configuration. Additionally, when using the external oscillator circuit in crystal/resonator, capacitor, or RC mode, the associated Port pins should be configured as **analog inputs**. In CMOS clock mode, the associated pin should be configured as a **digital input**. See **Section “12.2. Port I/O Initialization” on page 106** for details on Port input mode selection.

11.3. System Clock Selection

The CLKSL bit in register OSCICN selects which oscillator is used as the system clock. CLKSL must be set to ‘1’ for the system clock to run from the external oscillator; however the external oscillator may still clock peripherals (timers, PCA) when the internal oscillator is selected as the system clock. The system clock may be switched on-the-fly between the internal and external oscillator, so long as the selected oscillator is enabled and has settled. The internal oscillator requires little start-up time and may be enabled and selected as the system clock in the same write to OSCICN. External crystals and ceramic resonators typically require a start-up time before they are settled and ready for use as the system clock. The Crystal Valid Flag (XTLVLD in register OSCXCN) is set to ‘1’ by hardware when the external oscillator is settled. To avoid reading a false XTLVLD, in crystal mode software should delay at least 1 ms between enabling the external oscillator and checking XTLVLD. RC and C modes typically require no start-up time.

14.1. Enhanced Baud Rate Generation

The UART0 baud rate is generated by Timer 1 in 8-bit auto-reload mode. The TX clock is generated by TL1; the RX clock is generated by a copy of TL1 (shown as RX Timer in Figure 14.2), which is not user accessible. Both TX and RX Timer overflows are divided by two to generate the TX and RX baud rates. The RX Timer runs when Timer 1 is enabled, and uses the same reload value (TH1). However, an RX Timer reload is forced when a START condition is detected on the RX pin. This allows a receive to begin any time a START is detected, independent of the TX Timer state.

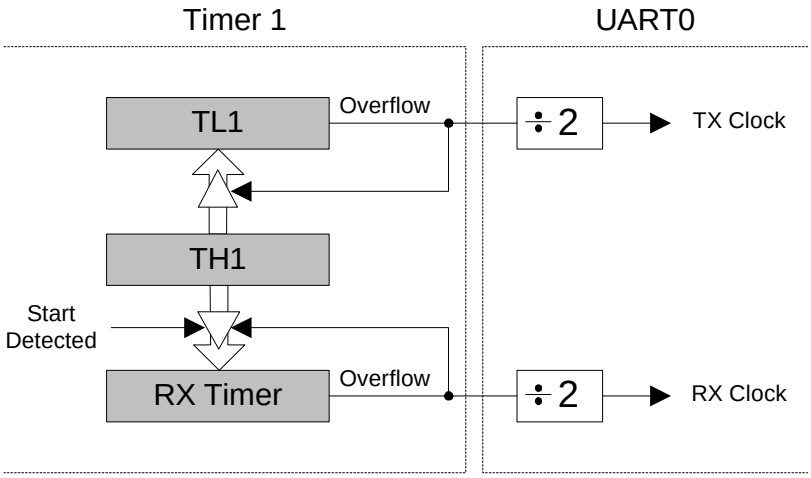

Figure 14.2. UART0 Baud Rate Logic

Timer 1 should be configured for Mode 2, 8-bit auto-reload (see **Section "15.1.3. Mode 2: 8-bit Counter/Timer with Auto-Reload" on page 145**). The Timer 1 reload value should be set so that overflows will occur at two times the desired UART baud rate frequency. Note that Timer 1 may be clocked by one of five sources: SYSCLK, SYSCLK / 4, SYSCLK / 12, SYSCLK / 48, or the external oscillator clock / 8. For any given Timer 1 clock source, the UART0 baud rate is determined by Equation 14.1.

$$UartBaudRate = \frac{T1_{CLK}}{(256 - T1H)} \times \frac{1}{2}$$

Equation 14.1. UART0 Baud Rate

Where $T1_{CLK}$ is the frequency of the clock supplied to Timer 1, and *T1H* is the high byte of Timer 1 (reload value). Timer 1 clock frequency is selected as described in **Section "15.2. Timer 2" on page 151**. A quick reference for typical baud rates and system clock frequencies is given in Tables 14.1 through 14.6. Note that the internal oscillator may still generate the system clock when the external oscillator is driving Timer 1 (see **Section "15.1. Timer 0 and Timer 1" on page 143** for more details).

14.2. Operational Modes

UART0 provides standard asynchronous, full duplex communication. The UART mode (8-bit or 9-bit) is selected by the S0MODE bit (SCON0.7). Typical UART connection options are shown below.

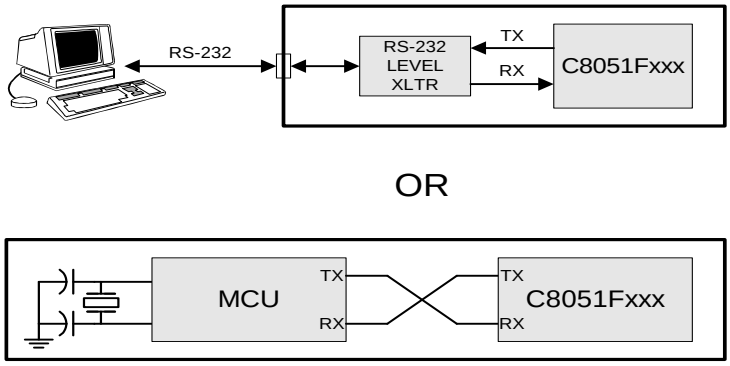

Figure 14.3. UART Interconnect Diagram

14.2.1. 8-Bit UART

8-Bit UART mode uses a total of 10 bits per data byte: one start bit, eight data bits (LSB first), and one stop bit. Data are transmitted LSB first from the TX pin and received at the RX pin. On receive, the eight data bits are stored in SBUF0 and the stop bit goes into RB80 (SCON0.2).

Data transmission begins when software writes a data byte to the SBUF0 register. The TI0 Transmit Interrupt Flag (SCON0.1) is set at the end of the transmission (the beginning of the stop-bit time). Data reception can begin any time after the REN0 Receive Enable bit (SCON0.4) is set to logic 1. After the stop bit is received, the data byte will be loaded into the SBUF0 receive register if the following conditions are met: RI0 must be logic 0, and if MCE0 is logic 1, the stop bit must be logic 1. In the event of a receive data overrun, the first received 8 bits are latched into the SBUF0 receive register and the following overrun data bits are lost.

If these conditions are met, the eight bits of data is stored in SBUF0, the stop bit is stored in RB80 and the RI0 flag is set. If these conditions are not met, SBUF0 and RB80 will not be loaded and the RI0 flag will not be set. An interrupt will occur if enabled when either TI0 or RI0 is set.

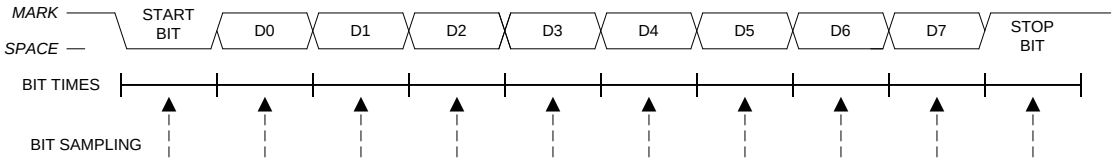

Figure 14.4. 8-Bit UART Timing Diagram

16.2. Capture/Compare Modules

Each module can be configured to operate independently in one of six operation modes: Edge-triggered Capture, Software Timer, High Speed Output, Frequency Output, 8-bit Pulse Width Modulator, or 16-bit Pulse Width Modulator. Each module has Special Function Registers (SFRs) associated with it in the CIP-51 system controller. These registers are used to exchange data with a module and configure the module's mode of operation.

Table 16.2 summarizes the bit settings in the PCA0CPMn registers used to select the PCA capture/compare module's operating modes. Setting the ECCFn bit in a PCA0CPMn register enables the module's CCFn interrupt. Note: PCA0 interrupts must be globally enabled before individual CCFn interrupts are recognized. PCA0 interrupts are globally enabled by setting the EA bit and the EPCA0 bit to logic 1. See Figure 16.3 for details on the PCA interrupt configuration.

Table 16.2. PCA0CPM Register Settings for PCA Capture/Compare Modules

PWM16	ECOM	CAPP	CAPN	MAT	TOG	PWM	ECCF	Operation Mode
X*	X*	1	0	0	0	0	X*	Capture triggered by positive edge on CEXn
X*	X*	0	1	0	0	0	X*	Capture triggered by negative edge on CEXn
X*	X*	1	1	0	0	0	X*	Capture triggered by transition on CEXn
X*	1	0	0	1	0	0	X*	Software Timer
X*	1	0	0	1	1	0	X*	High Speed Output
X*	1	0	0	X*	1	1	X*	Frequency Output
0	1	0	0	X*	0	1	X*	8-bit Pulse Width Modulator
1	1	0	0	X*	0	1	X*	16-bit Pulse Width Modulator

***Note:** X = Don't Care

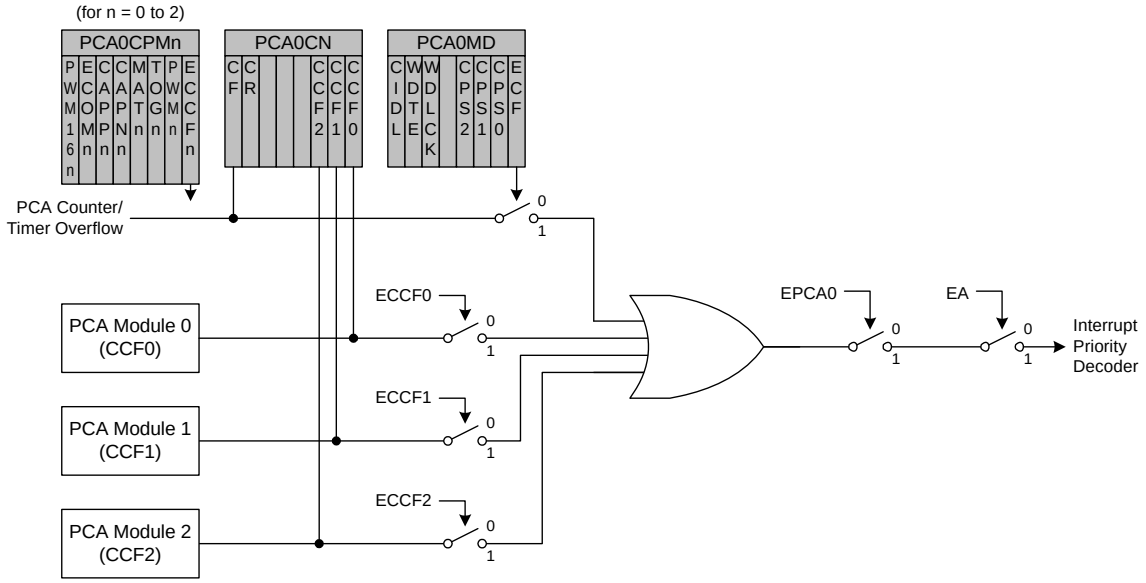

Figure 16.3. PCA Interrupt Block Diagram

Note that the 8-bit offset held in PCA0CPH2 is compared to the upper byte of the 16-bit PCA counter. This offset value is the number of PCA0L overflows before a reset. Up to 256 PCA clocks may pass before the first PCA0L overflow occurs, depending on the value of the PCA0L when the update is performed. The total offset is then given (in PCA clocks) by Equation 16.4, where PCA0L is the value of the PCA0L register at the time of the update.

$$Offset = (256 \times PCA0CPL2) + (256 - PCA0L)$$

Equation 16.4. Watchdog Timer Offset in PCA Clocks

The WDT reset is generated when PCA0L overflows while there is a match between PCA0CPH2 and PCA0H. Software may force a WDT reset by writing a ‘1’ to the CCF2 flag (PCA0CN.2) while the WDT is enabled.

16.3.2. Watchdog Timer Usage

To configure the WDT, perform the following tasks:

- Disable the WDT by writing a ‘0’ to the WDTE bit.
- Select the desired PCA clock source (with the CPS2–CPS0 bits).
- Load PCA0CPL2 with the desired WDT update offset value.
- Configure the PCA Idle mode (set CIDL if the WDT should be suspended while the CPU is in Idle mode).
- Enable the WDT by setting the WDTE bit to ‘1’.
- Reload the WDT by writing any value to PCA0CPH2.

The PCA clock source and Idle mode select cannot be changed while the WDT is enabled. The Watchdog Timer is enabled by setting the WDTE or WDLCK bits in the PCA0MD register. When WDLCK is set, the WDT cannot be disabled until the next system reset. If WDLCK is not set, the WDT is disabled by clearing the WDTE bit.

The WDT is enabled following any reset. The PCA0 counter clock defaults to the system clock divided by 12, PCA0L defaults to 0x00, and PCA0CPL2 defaults to 0x00. Using Equation 16.4, this results in a WDT timeout interval of 3072 system clock cycles. Table 16.3 lists some example timeout intervals for typical system clocks, assuming SYSCLK / 12 as the PCA clock source.

SFR Definition 16.2. PCA0MD: PCA Mode

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
CIDL	WDTE	WDLCK	—	CPS2	CPS1	CPS0	ECF	01000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xD9

Bit7: CIDL: PCA Counter/Timer Idle Control.
Specifies PCA behavior when CPU is in Idle Mode.
0: PCA continues to function normally while the system controller is in Idle Mode.
1: PCA operation is suspended while the system controller is in Idle Mode.

Bit6: WDTE: Watchdog Timer Enable
If this bit is set, PCA Module 2 is used as the Watchdog Timer.
0: Watchdog Timer disabled.
1: PCA Module 2 enabled as Watchdog Timer.

Bit5: WDLCK: Watchdog Timer Lock
This bit locks/unlocks the Watchdog Timer Enable. When WDLCK is set, the Watchdog Timer may not be disabled until the next system reset.
0: Watchdog Timer Enable unlocked.
1: Watchdog Timer Enable locked.

Bit4: UNUSED. Read = 0b, Write = don't care.

Bits3–1: CPS2–CPS0: PCA Counter/Timer Pulse Select.
These bits select the clock source for the PCA counter

CPS2	CPS1	CPS0	Timebase
0	0	0	System clock divided by 12
0	0	1	System clock divided by 4
0	1	0	Timer 0 overflow
0	1	1	High-to-low transitions on ECI (max rate = system clock divided by 4)
1	0	0	System clock
1	0	1	External clock divided by 8*
1	1	0	Reserved
1	1	1	Reserved

***Note:** External oscillator source divided by 8 is synchronized with the system clock.

Bit0: ECF: PCA Counter/Timer Overflow Interrupt Enable.
This bit sets the masking of the PCA Counter/Timer Overflow (CF) interrupt.
0: Disable the CF interrupt.
1: Enable a PCA Counter/Timer Overflow interrupt when CF (PCA0CN.7) is set.

Note: When the WDTE bit is set to '1', the PCA0MD register cannot be modified. To change the contents of the PCA0MD register, the Watchdog Timer must first be disabled.

SFR Definition 16.3. PCA0CPMn: PCA Capture/Compare Mode

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
PWM16n	ECOMn	CAPPn	CAPNn	MATn	TOGn	PWMn	ECCFn	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address:
								0xDA, 0xDB, 0xDC

PCA0CPMn Address: PCA0CPM0 = 0xDA (n = 0)
PCA0CPM1 = 0xDB (n = 1)
PCA0CPM2 = 0xDC (n = 2)

Bit7: PWM16n: 16-bit Pulse Width Modulation Enable.
This bit selects 16-bit mode when Pulse Width Modulation mode is enabled (PWMn = 1).
0: 8-bit PWM selected.
1: 16-bit PWM selected.

Bit6: ECOMn: Comparator Function Enable.
This bit enables/disables the comparator function for PCA Module n.
0: Disabled.
1: Enabled.

Bit5: CAPPn: Capture Positive Function Enable.
This bit enables/disables the positive edge capture for PCA Module n.
0: Disabled.
1: Enabled.

Bit4: CAPNn: Capture Negative Function Enable.
This bit enables/disables the negative edge capture for PCA Module n.
0: Disabled.
1: Enabled.

Bit3: MATn: Match Function Enable.
This bit enables/disables the match function for PCA Module n. When enabled, matches of the PCA counter with a module's capture/compare register cause the CCFn bit in PCA0MD register to be set to logic 1.
0: Disabled.
1: Enabled.

Bit2: TOGn: Toggle Function Enable.
This bit enables/disables the toggle function for PCA Module n. When enabled, matches of the PCA counter with a module's capture/compare register cause the logic level on the CEXn pin to toggle. If the PWMn bit is also set to logic 1, the module operates in Frequency Output Mode.
0: Disabled.
1: Enabled.

Bit1: PWMn: Pulse Width Modulation Mode Enable.
This bit enables/disables the PWM function for PCA Module n. When enabled, a pulse width modulated signal is output on the CEXn pin. 8-bit PWM is used if PWM16n is cleared; 16-bit mode is used if PWM16n is set to logic 1. If the TOGn bit is also set, the module operates in Frequency Output Mode.
0: Disabled.
1: Enabled.

Bit0: ECCFn: Capture/Compare Flag Interrupt Enable.
This bit sets the masking of the Capture/Compare Flag (CCFn) interrupt.
0: Disable CCFn interrupts.
1: Enable a Capture/Compare Flag interrupt request when CCFn is set.

SFR Definition 16.6. PCA0CPLn: PCA Capture Module Low Byte

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address:
								0xFB, 0xE9, 0xEB

PCA0CPLn Address: PCA0CPL0 = 0xFB (n = 0)
PCA0CPL1 = 0xE9 (n = 1)
PCA0CPL2 = 0xEB (n = 2)

Bits7–0: PCA0CPLn: PCA Capture Module Low Byte.
The PCA0CPLn register holds the low byte (LSB) of the 16-bit capture Module n.

SFR Definition 16.7. PCA0CPHn: PCA Capture Module High Byte

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address:
								0xFC, 0xEA, 0xEC

PCA0CPHn Address: PCA0CPH0 = 0xFC (n = 0)
PCA0CPH1 = 0xEA (n = 1)
PCA0CPH2 = 0xEC(n = 2)

Bits7–0: PCA0CPHn: PCA Capture Module High Byte.
The PCA0CPHn register holds the high byte (MSB) of the 16-bit capture Module n.